



Trusted Foundry Program

As of September 24, 2020

Accredited Suppliers

Important: Many of the following suppliers have a standard commercial (untrusted) product flow in addition to a trusted product flow. The "Trusted Product Flow" must be explicitly requested from the points of contact below to ensure the resulting product and/or service is trusted. A trusted supply chain begins with trusted design and continues with trusted mask, foundry, packaging/assembly, and test services.

Supplier	CAGE Code	Facility Location	Scope of Accreditation	POC	Email Address	Telephone Number
AccelerATE Solutions, Inc.	4ESJ8	San Jose, CA	Broker; Design	Thomas Nulsen	nulsente@acceler-ate.com	(408) 218-1978
Alion Science and Technology	6V5Z8	Roanoke, VA	Design	Barry Polakowski	Barry.Polakowski@alionscience.com	(540) 283-7555
Arkham Technology Ltd.	47RG0	Irvine, CA	Design	Otaway Thomas	othomas@arkhamtechnology.com	(949) 585-0404
Atessa, Inc.	66UM6	Pleasanton, CA	Design	Marketing Manager	info@atessainc.com	(925) 469-0063
BAE Systems Electronic Systems	1RU44	Manassas, VA	Broker; Design; Aggregation; Packaging/Assembly; Test	Stewart Ocheltree	trustedmicro.vams@baesystems.com	(571) 364-7624
BAE Systems Microelectronics Center Nashua	94117	Nashua, NH	Foundry Services	John Woodhouse	john.woodhouse4@baesystems.com	(603) 885-9570
Boeing Company	81205	Seattle, WA	Design	Michael Carson	Michael.w.carson@boeing.com	(253) 657-8056
Boeing Defense, Space and Security	9E831	El Segundo, CA	Design; Test	Eric Miller	Eric.J.Miller@boeing.com	(310) 416-5314
Cobham Colorado Spring Inc.	65342	Colorado Springs, CO	Broker; Design; Aggregation; Packaging/Assembly; Test	Michael Newman	mike.newman@cobhamaes.com	(719) 888-0114
Cobham Long Island	88379	Plainview, NY	Packaging/Assembly	Ronald Vogt	Ronald.Vogt@cobhamaes.com	(516) 752-2448
Collins Aerospace	13499	Cedar Rapids, IA	Design; Packaging/Assembly; Test	John Mulherin	john.mulherin@rockwellcollins.com	(319) 295-1703
CREE, Inc.	0C9J8	Durham, NC	Design; Foundry Services; Test	Richie Richards	rrichards@cree.com	(919) 407-6054
Criteria Labs, Inc.	1NQ10	Austin, TX	Broker; Packaging/Assembly; Test	Doug Myron	dmyron@criterialabs.com	(512) 637-4549
Cubic Nuvotronics	5K5D0	Durham, NC	Post Processing; Packaging/Assembly	Mr. Greg Bolick, Security Manager/FSO 919 283-2163	greg.bolick@cubic.com	(919) 283-2163
Defense Microelectronics Activity	088N9	McClellan, CA	Broker; Design; Foundry Services; Packaging/Assembly; Test	Soon Chang	soon.w.chang2.civ@mail.mil	(916) 999-2782
Department of Defense Microelectronics Solutions Group	98230	Fort Meade, MD	Design; Packaging/Assembly; Test	Keith L. Rogers, Ph.D.	klroger@radium.ncsc.mil	(240) 373-2990
DPA Components International	6S055	Simi Valley, CA	Packaging/Assembly; Test	Doug Schweitzer	dougs@dpaci.com	(805) 581-9200
Draper	51993	Cambridge, MA	Design; Post Processing; Packaging/Assembly; Test	Christopher O'Keefe	S&AS@draper.com	(617) 258-1576
FirstPass Engineering (Phoenix)	6WFA9	Phoenix, AZ	Design	Brad Bailey	bbailey@firstpasseng.com	(480) 426-8933
General Dynamics Mission Systems	3CYA2	Bloomington, MN	Broker; Design	Ray Keele	Ray.keele@gd-ms.com	(916) 246-5492
General Dynamics Mission Systems, Scottsdale	1VPW8	Scottsdale, AZ	Broker; Design	James Garvey	James.Garvey@gd-ms.com	(480) 586-3355

GLOBALFOUNDRIES U.S. 2 LLC BTV	7DR37	Essex Junction, VT	Broker; Design; Aggregation; Mask Data Parsing; Mask Manufacturing; Foundry Services; Post Processing; Test	Ghassan Zamat	ghassan.zamat@globalfoundries.com	(240) 780-8875
GLOBALFOUNDRIES U.S. 2 LLC EFK	7DR38	Hopewell Junction, NY	Foundry Services; Post Processing	Ghassan Zamat	ghassan.zamat@globalfoundries.com	(240) 780-8875
Grinding & Dicing Services Inc.	3FEJ2	San Jose, CA	Post Processing; Packaging/Assembly	General Manager	info@wafergrind.com	(408) 961-3720
Honeywell Aerospace Plymouth	34168	Plymouth, MN	Broker; Design; Foundry Services; Packaging/Assembly; Test	Thomas Romanko	Thomas.romanko@honeywell.com	(763) 954-2103
HRL Laboratories, LLC.	27457	Malibu, CA	Foundry Services	Kay Son, Ph.D.	kson@hrl.com	(310) 317-5977
i3 Electronics, Inc.	70S94	Binghamton, NY	Packaging/Assembly	Michelle Eldred	Michelle.Eldred@i3electronics.com	(607) 238-7077 ext 318
i3 Microsystems, Inc.	80UM5	St. Petersburg, FL 33716	Post Processing; Packaging/Assembly	Justin Borski	justin.borski@i3electronics.com	(607) 238-7077 ext 318
IBM Corporation Bromont	L04D9	Bromont, Quebec, Canada	Post Processing; Packaging/Assembly	Claude Letendre	cletendr@ca.ibm.com	(919) 830-5614
IBM Corporation Burlington	15898	Essex Junction, VT	Broker	Michael James	jamm@us.ibm.com	(802) 769-5069
IBM Corporation East Fishkill	1D185	Hopewell Junction, NY	Broker	Michael James	jamm@us.ibm.com	(802) 769-5069
Integra Technologies Albuquerque	3DR22	Albuquerque, NM	Test	Mark Gores	mark.gores@integra-tech.com	(505) 765-2483
Integra Technologies Silicon Valley	061F4	Milpitas, CA	Post Processing; Packaging/Assembly	Joe Foerstel	joe.foerstel@integra-tech.com	(408) 618-8752
Integra Technologies, LLC	1SRY1	Wichita, KS	Broker; Test	Kelly Priddy	kelly.priddy@integra-tech.com	(316) 630-6859
Intrinsix Corp.	0N6C1	Marlborough, MA	Broker; Design	Jim Gobes, CEO	jgobes@intrinsix.com	(508) 658-7658
Jazz Semiconductor Trusted Foundry (JSTF)	6PN00	Irvine, CA	Broker	Scott Jordan	Jordans1@jazztrusted.com	(949) 861-3519
Johns Hopkins University, Applied Physics Laboratory	88898	Laurel, MD	Design	Shawn Seman	shawn.seman@jhuapl.edu	(240) 228-2843
Kansas City National Security Campus	14061	Kansas City, MO	Broker; Design; Aggregation; Post Processing; Packaging/Assembly; Test	Wayne Reed	wreed@kcp.doe.gov	(816) 488-3965
L-3 Communications Systems - West	06401	Salt Lake City, UT	Design	Eric Hall	Eric.k.hall@L3Harris.com	(801) 594-2601
L3Harris Corporation Space & Airborne Systems	91417	Melbourne, FL	Design; Packaging/Assembly; Test	Louis Paradiso, Group Leader	lparadis@harris.com	(321) 727-1989
Lockheed Martin Missiles and Fire Control, Orlando	04939	Orlando, FL	Design	Zachary Davis	zachary.n.davis@lmco.com	(407) 356-1683
Lockheed Martin Space Systems Company, Denver	04236	Littleton, CO	Design	Deanna Doner, Sr. Manager ASIC/FPGA Design Services	deanna.e.doner@lmco.com	(303) 971-5392
Lockheed Martin Space Systems Company, Sunnyvale	06887	Sunnyvale, CA	Design	Deanna Doner, Sr. Manager ASIC/FPGA Design Services	deanna.e.doner@lmco.com	(303) 971-5392
Lockheed Martin Space Systems Company, Valley Forge	79272	King of Prussia, PA	Design	Deanna Doner, Sr. Manager ASIC/FPGA Design Services	deanna.e.doner@lmco.com	(303) 971-5392

M/A-COM Technology Solutions Inc.	55NN2	Lowell,MA	Foundry Services; Post Processing	Shaun Neylon	shaun.neylon@macom.com	(978) 656-2345
Marvell Government Solutions, LLC	898N6	Essex Junction, VT	Broker; Design; Test	Richard Molino	mrich@marvellgs.com	(845) 892-0754
Maxtek Components Corp. dba Tektronix Component Solutions	06MJ2	Beaverton, OR	Packaging/Assembly; Test	Andrew Saxton	andrew.saxton@tektronix.com	(503) 627-2232
Mercury System, Inc. - Phoenix Advanced Microelectronics Center	54230	Phoenix, AZ	Broker; Packaging/Assembly; Test	Trusted Supplier	support@mrchy.com	(360) 921-8943
Mercury Systems - Sensor and Mission Processing	3X893	Andover, MA	Design	Trusted Supplier	support@mrchy.com	(657) 465-0208
Microsemi a subsidiary of Microchip Corp	0J4Z0	San Jose, CA	Broker; Design; Test	Paul Quintana	paul.quintana@microchip.com	(408) 643-6200
Microsemi a subsidiary of Microchip Corp, Allentown	6WGS8	Allentown, PA	Broker; Design; Aggregation; Test	Wayne Robert Kohler	wayne.kohler@microchip.com	(408) 643-6040
Micross Advance Interconnect Technology	7OZQ8	Durham, North Carolina	Post Processing	Alan Huffman/John Lannon	Alan.Huffman@micross.com / John.Lannon@micross.com	(919) 248-9216 / (919) 248-1872
MIT Lincoln Laboratory Microelectronics Laboratory	3G050	Lexington, MA	Design; Aggregation; Foundry Services; Post Processing; Packaging/Assembly	Dan Pulver	MEL-Director@ll.mit.edu	(781) 981-1716
NEO Tech	09059	Chatsworth, CA	Packaging/Assembly	Steve Heinzen V.P. Marketing	steve.heinzen@neotech.com	(510) 933-6065
Northrop Grumman Mission Systems	15055	Linthicum, MD	Broker; Foundry Services; Packaging/Assembly; Test	Jeff Miller	j3.miller@ngc.com	(410) 765-3958
Northrop Grumman Space Systems	11982	Redondo Beach, CA	Design; Aggregation; Foundry Services; Post Processing; Packaging/Assembly; Test	Myra de Leon	myra.deleon@ngc.com	(310) 813-2719
ON Semiconductor - Gresham	5V1J0	Gresham, OR	Broker; Foundry Services; Post Processing	Terry Danzer	terry.danzer@onsemi.com	(208) 234-6009
ON Semiconductor - Pocatello	31471	Pocatello, ID	Broker; Design; Foundry Services; Test	Terry Danzer	terry.danzer@onsemi.com	(208) 234-6009
Photonics Idaho, Inc.	860F3	Boise, ID	Mask Data Parsing; Mask Manufacturing	Wayne DeCarlo	wdecarlo@photonics.com	(203) 482-3290
Photonics Texas Allen, Inc.	53Z12	Allen, TX	Mask Data Parsing; Mask Manufacturing	Wayne DeCarlo	wdecarlo@photonics.com	(203) 482-3290
Plexus Aerospace Defense and Security Services LLC	76QV7	Nampa, ID	Packaging/Assembly	Daniel Marsh Director, Market Development	daniel.marsh@plexus.com	(480) 532-2467
Qorvo Texas, LLC	1CVM1	Richardson, TX	Foundry Services; Post Processing; Packaging/Assembly; Test	Douglas Cole	TrustedIC@qorvo.com	(972) 994-3965
Raytheon Missile and Defense	15090	Tucson, AZ	Broker; Design	Bryon Hoinke	bryon_hoinke@raytheon.com	(520) 794-4226
Raytheon RF Components	05716	Andover, MA	Foundry Services	Ronald Gyurcsik, Ph.D. Director, Foundry Business Development	ronald.gyurcsik@raytheon.com	(978) 684-5428
Raytheon Space and Airborne Systems, El Segundo	4U884	El Segundo, CA	Design; Test	David E. Lewis	delewis@raytheon.com	(310) 607-7878
Raytheon Space and Airborne Systems, McKinney	96214	McKinney, TX	Design	David E. Lewis	delewis@raytheon.com	(310) 607-7878

Raytheon Vision Systems	11323	Goleta, CA	Design	Eric Beuville, PH.D.	Eric_Beuville@Raytheon.com	(805) 562-2021
Sandia National Laboratories Microsystems Engineering, Science & Applications (MESA)	14213	Albuquerque, NM	Design; Foundry Services; Test	Nathan Nowlin, Manager, Advanced Microsystems Radiation Effects	nnowlin@sandia.gov	(505) 284-5782
Sensors Unlimited, Inc.	0TGF6	Princeton, NJ	Aggregation; Post Processing; Packaging/Assembly; Test	Keith Fitzpatrick	Keith.Fitzpatrick@collins.com	(609)333-8346
Silicon Turnkey Solutions, Inc.	1VPP6	Milpitas, CA	Packaging/Assembly; Test	Jim Will	jwill@sts-usa.com	(816) 509 7846
Six Sigma (dba)	1PBC8	Milpitas, CA	Packaging/Assembly	Russ Winslow	russ@solderquik.com	(408) 956-0100 x111
SkyWater Technology Foundry, Inc.	5AZZ0	Bloomington, MN	Broker; Design; Foundry Services; Test	Brad Ferguson, CTO	brad.ferguson@skywatertechnology.com	(952) 851-5190
SRI International	0DKS7	Princeton, NJ	Foundry Services	David Weaver, PhD	David.weaver@sri.com	(609) 720-4845
Teledyne Advanced Electronics Solutions	26687	Lewisburg, TN	Packaging/Assembly; Test	James W Murray JR. Director of Program Management	jmurray@teledyne.com	(931) 270-2735
Teledyne e2v HiRel Electronics	0C7V7	Milpitas, CA	Broker; Design; Packaging/Assembly; Test	Mont Taylor Dir. of Business Development	Mont.Taylor@Teledyne.com	(408) 609-8787
TLMI Corporation	3G0L2	Austin, TX	Post Processing	Michael Fredin	mfredin@tlmicorp.com	(512) 833-7075
Trusted Semiconductor Solutions Inc.	4LZE5	Brooklyn Park, MN	Broker; Design; Aggregation	Stephanie Pusch	stephanie.pusch@trustedsemi.com	(612) 618-2115
TSI Semiconductors America, LLC	6SKN8	Roseville, CA	Foundry Services; Post Processing	Wilbur Catabay	wilbur.catabay@tsisemi.com	(408) 678-8691
USC, Information Sciences Institute, Arlington	06SU2	Arlington, VA	Design	Matthew French	mfrench@isi.edu	(703) 812-3733
USC-ISI - MOSIS	1B729	Marina del Rey, CA	Broker; Aggregation	Jaimie Kohls	jkohls@isi.edu	(310) 448-8214
Vortex Aerospace Design & Labs, Inc.	35TC6	Melbourne, FL	Broker; Design; Aggregation; Mask Data Parsing	Curtis Turner	trustedDesign@vortexaerospace.com	(813) 435-0528

The Defense MicroElectronics Activity (DMEA) has been designated by the Department of Defense as the accrediting authority for this program. Send questions or comments to TrustedIC@dmea.osd.mil or call (916) 231-1514.



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- Design
- Aggregation
- Broker
- Mask Data Parsing
- Mask Manufacturing
- Foundry
- Post-Processing
- Packaging/Assembly
- Test

